

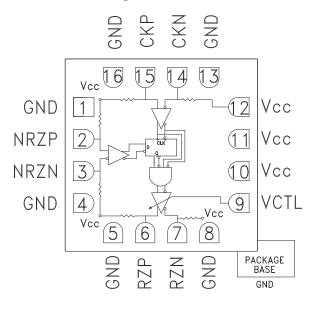


#### Typical Applications

The HMC706LC3C is ideal for:

- NRZ-to-RZ data type conversion
- SONET OC-192 applications and equipment
- Mach-Zehnder optical modulator drivers
- Broadband test & measurement

## **Functional Diagram**



#### **Features**

Supports High Data Rates: up to 13 Gbps Differential & Single-Ended Operation Fast Rise and Fall Times: 15 / 13 ps Low Power Consumption: 594 mW typ.

Programmable Differential

Output Voltage Swing: 300 - 1200 mV

Propagation Delay: 275 ps Single Supply: +3.3V

16 Lead Ceramic 3x3mm SMT Package: 9mm²

#### General Description

The HMC706LC3C is a NRZ-to-RZ converter designed to support data transmission rates of up to 13 Gbps, and clock frequencies as high as 13 GHz. During normal operation, RZ data is transferred to the outputs on the positive edge of the clock. Reversing the clock inputs allows for negative-edge triggered applications. All input signals to the HMC706LC3C are terminated with 50 Ohms to Vcc on-chip, and may be either AC or DC coupled.

The differential outputs of the HMC706LC3C may be either AC or DC coupled. Outputs can be connected directly to a 50 Ohm Vcc terminated system, while DC blocking capacitors may be used if the terminating system is 50 Ohms to a non-Vcc DC voltage. The 50 Ohm termination resistors are bypassed on chip from Vcc to ground. The HMC706LC3C operates from a single +3.3V DC supply and is available in a ceramic RoHS compliant 3x3 mm SMT package.

## Electrical Specifications, $T_A = +25^{\circ}\text{C}$ , Vcc = +3.3V

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| Parameter            | Conditions                 | Min.     | Тур. | Max      | Units |
|----------------------|----------------------------|----------|------|----------|-------|
| Power Supply Voltage |                            | 3.0      | 3.3  | 3.6      | V     |
| Power Supply Current |                            |          | 180  |          | mA    |
| Maximum Data Rate    |                            |          | 13   |          | Gbps  |
| Maximum Clock Rate   |                            |          | 13   |          | GHz   |
| Input High Voltage   |                            | Vcc -0.5 |      | Vcc +0.5 | V     |
| Input Low Voltage    |                            | Vcc -1.1 |      | Vcc      | V     |
| Input Return Loss    | Frequency <13 GHz          |          | 12   |          | dB    |
| Input Ampliftude     | Single-Ended, peak-to-peak | 50       |      | 1200     | mVp-p |
| Input Amplitude      | Differential, peak-to-peak | 100      |      | 2000     | mVp-p |
| Adjustable           | Single-Ended, peak-to-peak | 150      |      | 600      | mVp-p |
| Output Amplitude     | Differential, peak-to-peak | 300      |      | 1200     | mVp-p |
| Output High Voltage  |                            |          | 3.28 |          | V     |



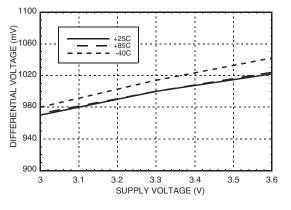


#### **Electrical Specifications**, (continued)

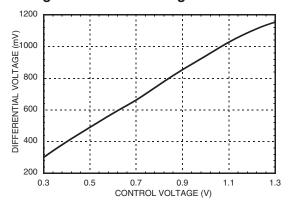
| Parameter                           | Conditions                                      | Min. | Тур.    | Max | Units   |
|-------------------------------------|-------------------------------------------------|------|---------|-----|---------|
| Output Low Voltage                  |                                                 |      | 2.76    |     | V       |
| Output Rise / Fall Time             | Differential, 20% - 80%                         |      | 15 / 13 |     | ps      |
| Output Return Loss                  | Frequency <13 GHz                               |      | 13.5    |     | dB      |
| Random Jitter Jr                    | rms <sup>[1]</sup>                              |      |         | 0.2 | ps rms  |
| Deterministic Jitter, Jd            | peak-to-peak, 2 <sup>31</sup> -1 PRBS input [2] |      | 2       |     | ps, p-p |
| Propagation Delay Clock to Data, td |                                                 |      | 275     |     | ps      |
| Clock Phase Margin                  | 13 GHz                                          |      | 270     |     | deg     |

<sup>[1]</sup> Measured at 12.5 Gbps continuous 1010.... input pattern.

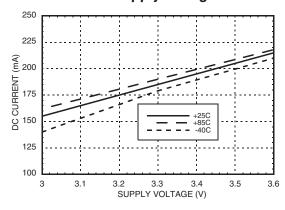
# Differential Output Voltage vs. Supply Voltage [1]



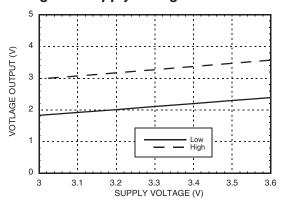
## Differential Output Voltage vs. Control Voltage



#### DC Current vs. Supply Voltage [1]



# Output Low Voltage, Output High Voltage vs. Supply Voltage [1] [2]



[1] Vctl = 1.1V

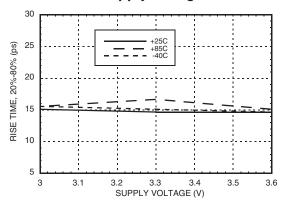
[2] Frequency = 13 GHz

<sup>[2]</sup> Deterministic jitter calculated by simultaneously measuring the edge by edge variation of the output data stream with respect to the input clock.

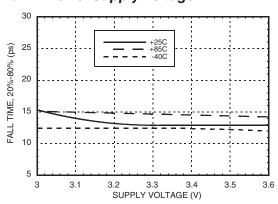




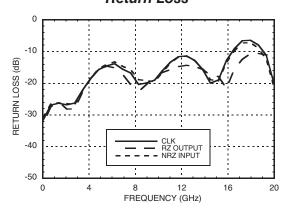
## Rise Time vs. Supply Voltage [1] [2]



Fall Time vs. Supply Voltage [1] [2]



#### **Return Loss**



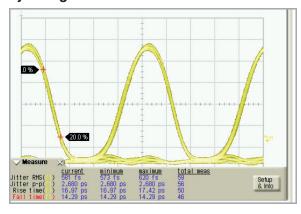
[1] Vctl = 1.1V

[2] Data Rate = 13 Gbps





## Eye Diagram [1]



[1] Test Conditions:

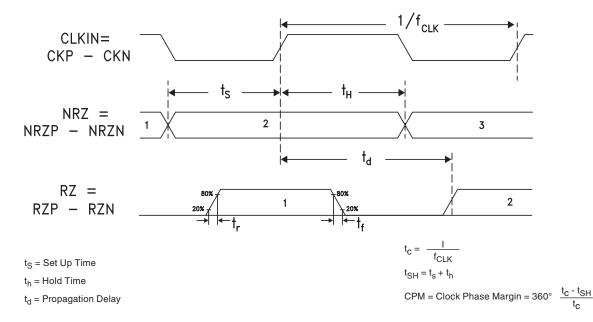
Eye diagram data presented on an Infinium DCA 86100A

Rate = 10.0 GB/s

Pseudo Random Code = 2<sup>31</sup> -1

Vin = 400 mVp-p differential

#### **Timing Diagram**



#### **Truth Table**

| Input                                               |                                                          | Outputs |
|-----------------------------------------------------|----------------------------------------------------------|---------|
| D                                                   | С                                                        | Q       |
| L                                                   | L -> H                                                   | L       |
| Н                                                   | L -> H                                                   | Н       |
| X                                                   | H -> L                                                   | L       |
| Notes:<br>D = DP - DN<br>C = CP - CN<br>Q = QP - QN | H - Negative voltage level<br>L - Positive voltage level |         |



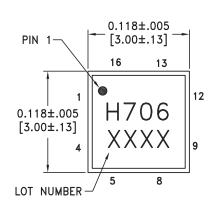


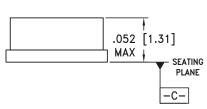
## **Absolute Maximum Ratings**

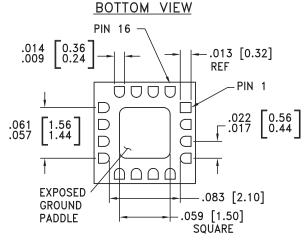
| Power Supply Voltage (Vcc) | -0.5V to +3.6V         |  |
|----------------------------|------------------------|--|
| Input Signals              | Vcc - 2V to Vcc + 0.5V |  |
| Output Signals             | Vcc -1.5V to Vcc +1.0V |  |
| Storage Temperature        | -65°C to +150°C        |  |
| Operating Temperature      | -40°C to +85°C         |  |



## **Outline Drawing**







#### NOTES:

- 1. PACKAGE BODY MATERIAL: ALUMINA
- 2. LEAD AND GROUND PADDLE PLATING:
- 30-80 MICROINCHES GOLD OVER 50 MICROINCHES MINIMUM NICKEL
- 3. DIMENSIONS ARE IN INCHES [MILLIMETERS].
- 4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm DATUM -C-
- 6. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.
- 7. GROUND PADDLE MUST BE SOLDERED TO GND.





## **Pin Descriptions**

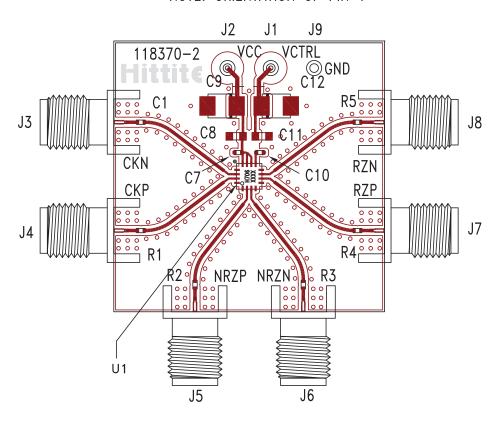
| Pin Number                             | Function   | Description            | Interface Schematic    |  |
|----------------------------------------|------------|------------------------|------------------------|--|
| 1, 4, 5, 8,<br>13, 16<br>Ground Paddle | GND        | Signal & Supply Ground | O Vec                  |  |
| 2, 3                                   | NRZP, NRZN | NRZ Data Inputs        | NRZP NRZN              |  |
| 6, 7                                   | RZP, RZN   | RZ Data Outputs        | Vcc<br>50 o RZN<br>RZP |  |
| 9                                      | Vctl       | Output Level Control   | Vcc                    |  |
| 10 - 12                                | Vcc        | Positive Supply        | O Vcc                  |  |
| 14, 15                                 | CKN, CKP   | Clock Inputs           | Vcc 50 o               |  |





#### **Evaluation PCB**

#### NOTE: ORIENTATION OF PIN 1



#### List of Materials for Evaluation PCB 118372 [1]

| Item       | Description                                         |  |
|------------|-----------------------------------------------------|--|
| J1, J2, J9 | DC Pin                                              |  |
| J3 - J8    | K Connector                                         |  |
| C1         | 10 pF Capacitor, 0402 Pkg.                          |  |
| C7         | 1 nF Capacitor, 0402 Pkg.                           |  |
| C8, C11    | 100 nF Capacitor, 0603 Pkg.                         |  |
| C9, C12    | 4.7 μF Case A, Tantalum                             |  |
| C10        | 100 pF Capacitor, 0402 Pkg.                         |  |
| R1 - R5    | 0 Ohm Resistor, 0402 Pkg.                           |  |
| U1         | HMC706LC3C<br>High Speed Logic, NRZ to RZ Converter |  |
| PCB [2]    | 118370 Evaluation Board                             |  |

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Arlon 25FR, FR4

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads should be connected directly to the ground plane similar to that shown. The exposed package base should be connected to ground. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.





## **Application Circuit**

